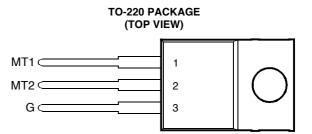
# BOURNS®



- Sensitive Gate Triacs
- 8 A RMS, 70 A Peak
- Glass Passivated Wafer
- 400 V to 800 V Off-State Voltage
- Max I<sub>GT</sub> of 5 mA (Quadrant 1)



Pin 2 is in electrical contact with the mounting base.



### absolute maximum ratings over operating case temperature (unless otherwise noted)

RATING	SYMBOL	VALUE	UNIT	
	TIC225D		400	
Repetitive peak off-state voltage (see Note 1)	TIC225M	V	600	V
	TIC225S	V <sub>DRM</sub>	700	v
	TIC225N		800	
Full-cycle RMS on-state current at (or below) 70°C case temperature (see Note 2)			8	A
Peak on-state surge current full-sine-wave at (or below) 25°C case temperature (see Note 3)			70	А
Peak gate current			±1	А
Peak gate power dissipation at (or below) 85°C case temperature (pulse width $\leq$ 200 $\mu$ s)			2.2	W
Average gate power dissipation at (or below) 85°C case temperature (see Note 4)			0.9	W
Operating case temperature range			-40 to +110	°C
Storage temperature range			-40 to +125	°C
Lead temperature 1.6 mm from case for 10 seconds			230	°C

NOTES: 1. These values apply bidirectionally for any value of resistance between the gate and Main Terminal 1.

 This value applies for 50-Hz full-sine-wave operation with resistive load. Above 70°C derate linearly to 110°C case temperature at the rate of 200 mA/°C.

- 3. This value applies for one 50-Hz full-sine-wave when the device is operating at (or below) the rated value of on-state current. Surge may be repeated after the device has returned to original thermal equilibrium. During the surge, gate control may be lost.
- 4. This value applies for a maximum averaging time of 20 ms.

#### electrical characteristics at 25°C case temperature (unless otherwise noted )

	PARAMETER	TEST CONDITIONS			MIN	ТҮР	MAX	UNIT
I <sub>DRM</sub>	Repetitive peak off-state current	$V_D$ = rated $V_{DRM}$	I <sub>G</sub> = 0	T <sub>C</sub> = 110°C			±2	mA
I <sub>GT</sub>	Gate trigger current	$V_{supply} = +12 V \dagger$ $V_{supply} = +12 V \dagger$ $V_{supply} = -12 V \dagger$ $V_{supply} = -12 V \dagger$	R <sub>L</sub> = 10 Ω R <sub>L</sub> = 10 Ω R <sub>L</sub> = 10 Ω R <sub>L</sub> = 10 Ω	t <sub>p(g)</sub> > 20 μs t <sub>p(g)</sub> > 20 μs t <sub>p(g)</sub> > 20 μs t <sub>p(g)</sub> > 20 μs		2.3 -3.8 -3 6	5 -20 -10 30	mA

† All voltages are with respect to Main Terminal 1.

## PRODUCT INFORMATION



## electrical characteristics at 25°C case temperature (unless otherwise noted) (continued)

PARAMETER		TEST CONDITIONS			MIN	TYP	MAX	UNIT
V <sub>GT</sub>	Gate trigger voltage	$V_{supply} = +12 V \dagger$ $V_{supply} = +12 V \dagger$ $V_{supply} = -12 V \dagger$ $V_{supply} = -12 V \dagger$	$R_{L} = 10 \Omega$ $R_{L} = 10 \Omega$ $R_{L} = 10 \Omega$ $R_{L} = 10 \Omega$	$t_{p(g)} > 20 \ \mu s$ $t_{p(g)} > 20 \ \mu s$		0.7 -0.7 -0.7 0.8	2 -2 -2 2	v
V <sub>T</sub>	On-state voltage	$I_T = \pm 12 \text{ A}$	I <sub>G</sub> = 50 mA	(see Note 5)		±1.5	±2.1	V
I <sub>H</sub>	Holding current	V <sub>supply</sub> = +12 V† V <sub>supply</sub> = -12 V†	$I_{G} = 0$ $I_{G} = 0$	Init' I <sub>T</sub> = 100 mA Init' I <sub>T</sub> = -100 mA		2.3 -1.6	20 -20	mA
ΙL	Latching current	$V_{supply} = +12 V^{\dagger}$ $V_{supply} = -12 V^{\dagger}$	(see Note 6)				30 -30	mA
dv/dt	Critical rate of rise of off-state voltage	V <sub>DRM</sub> = Rated V <sub>DRM</sub>	I <sub>G</sub> = 0	T <sub>C</sub> = 110°C		±20		V/µs
dv/dt <sub>(c)</sub>	Critical rise of commutation voltage	V <sub>DRM</sub> = Rated V <sub>DRM</sub>	$I_{\text{TRM}} = \pm 12 \text{ A}$	T <sub>C</sub> = 70°C (see Figure 6)	±1	±4.5		V/µs

† All voltages are with respect to Main Terminal 1.

NOTES: 5. This parameter must be measured using pulse techniques,  $t_p = \le 1$  ms, duty cycle  $\le 2$  %. Voltage-sensing contacts separate from the current carrying contacts are located within 3.2 mm from the device body.

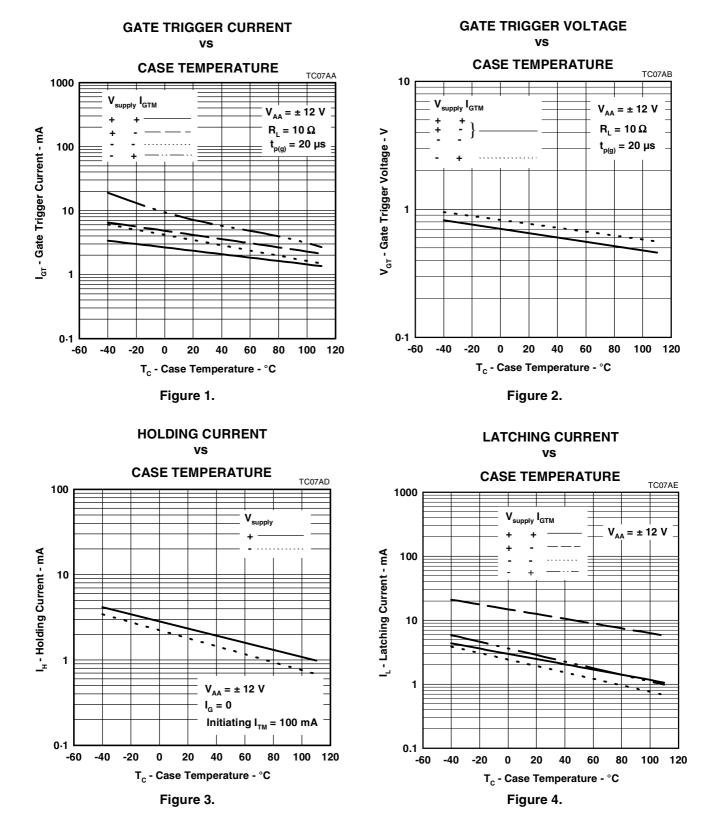
6. The triacs are triggered by a 15-V (open-circuit amplitude) pulse supplied by a generator with the following characteristics:  $R_G = 100 \Omega$ ,  $t_{p(g)} = 20 \mu s$ ,  $t_r = \le 15 ns$ , f = 1 kHz

#### thermal characteristics

PARAMETER			ТҮР	MAX	UNIT
$R_{\theta JC}$	Junction to case thermal resistance			2.5	°C/W
$R_{\thetaJA}$	Junction to free air thermal resistance			62.5	°C/W

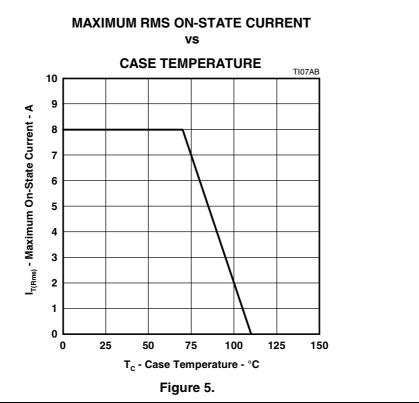


#### **TYPICAL CHARACTERISTICS**

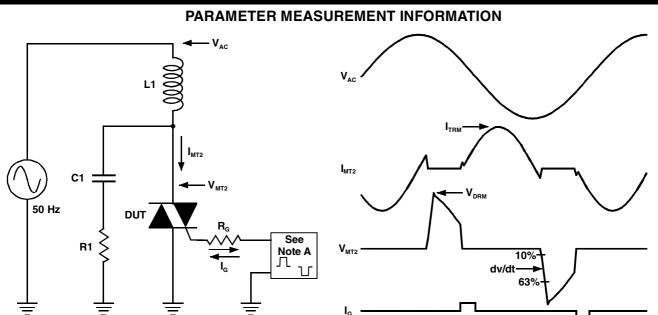


## PRODUCT INFORMATION

JULY 1975 - REVISED SEPTEMBER 2002 Specifications are subject to change without notice.



#### **THERMAL INFORMATION**



NOTE A: The gate-current pulse is furnished by a trigger circuit which presents essentially an open circuit between pulses. The pulse is timed so that the off-state-voltage duration is approximately 800 µs.

PMC2AA

Figure 6.

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